

Information Letter Number: 224201			Date: 22-Nov-2022	
Title: New Wirebonder for SHT3xA				
Product Identification: A	Il products of the SHT3xA f	amily		
Reason for Change:	Design	Production		
	Manufacturing Location	Quality/Reliability	Upgrade	
Change Description:				
quently, new processes for	or cleaning, wire bonding ar nd material; mold compound	nd transfer molding will be dev	nachine and new mold machine. Conse- veloped on new equipment. There is no ction of final sensors are not affected by	
Identification Method to	Distinguish Change:			
Identification Method to Samples:	Distinguish Change:	will be available in	⊠ not applicable	
Samples:			⊠ not applicable	
Samples:	□ available Quality & Reliability: No im		⊠ not applicable	
Samples: Quantifiable Impact on C Estimated Implementation	available Quality & Reliability: No im on Date*: 1st of May 2023	pact	Inot applicable	

If you have questions about this Information Letter, please send them to the Sensirion contact e-mail address listed above.